



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



$V_{CES}$	650V
$I_{C(100^{\circ}C)}$	25A
$V_{CE(sat)}$ (Typ.)	1.6V
$P_D$	174W

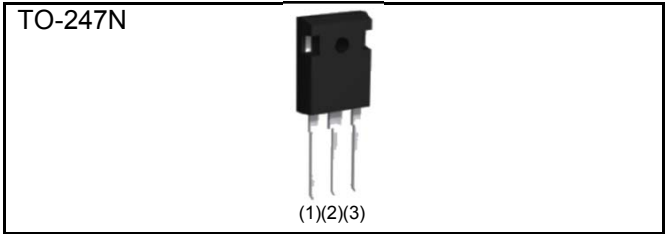
### ●Features

- 1) Low Collector - Emitter Saturation Voltage
- 2) High Speed Switching
- 3) Low Switching Loss & Soft Switching
- 4) Pb - free Lead Plating ; RoHS Compliant

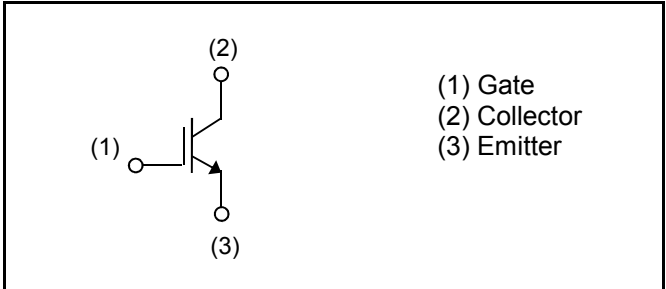
### ●Applications

- PFC
- UPS
- Power Conditioner
- IH

### ●Outline



### ●Inner Circuit



### ●Packaging Specifications

Type	Packaging	Tube
	Reel Size (mm)	-
	Tape Width (mm)	-
	Basic Ordering Unit (pcs)	450
	Packing code	C11
	Marking	RGTH50TS65

### ●Absolute Maximum Ratings (at $T_C = 25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Value	Unit	
Collector - Emitter Voltage	$V_{CES}$	650	V	
Gate - Emitter Voltage	$V_{GES}$	$\pm 30$	V	
Collector Current	$T_C = 25^{\circ}C$	$I_C$	50	A
	$T_C = 100^{\circ}C$	$I_C$	25	A
Pulsed Collector Current	$I_{CP}^{*1}$	100	A	
Power Dissipation	$T_C = 25^{\circ}C$	$P_D$	174	W
	$T_C = 100^{\circ}C$	$P_D$	87	W
Operating Junction Temperature	$T_j$	-40 to +175	$^{\circ}C$	
Storage Temperature	$T_{stg}$	-55 to +175	$^{\circ}C$	

\*1 Pulse width limited by  $T_{jmax}$ .

### ●Thermal Resistance

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	0.86	°C/W

### ●IGBT Electrical Characteristics (at $T_j = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Collector - Emitter Breakdown Voltage	$BV_{CES}$	$I_C = 10\mu\text{A}$ , $V_{GE} = 0\text{V}$	650	-	-	V
Collector Cut - off Current	$I_{CES}$	$V_{CE} = 650\text{V}$ , $V_{GE} = 0\text{V}$	-	-	10	$\mu\text{A}$
Gate - Emitter Leakage Current	$I_{GES}$	$V_{GE} = \pm 30\text{V}$ , $V_{CE} = 0\text{V}$	-	-	$\pm 200$	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 5\text{V}$ , $I_C = 17.5\text{mA}$	4.5	5.5	6.5	V
Collector - Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = 25\text{A}$ , $V_{GE} = 15\text{V}$	-	1.6	2.1	V
		$T_j = 25^\circ\text{C}$	-	2.1	-	
		$T_j = 175^\circ\text{C}$	-			

**●IGBT Electrical Characteristics** (at  $T_j = 25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Input Capacitance	$C_{ies}$	$V_{CE} = 30\text{V}$	-	1410	-	pF
Output Capacitance	$C_{oes}$	$V_{GE} = 0\text{V}$	-	57	-	
Reverse Transfer Capacitance	$C_{res}$	$f = 1\text{MHz}$	-	22	-	
Total Gate Charge	$Q_g$	$V_{CE} = 300\text{V}$	-	49	-	nC
Gate - Emitter Charge	$Q_{ge}$	$I_C = 25\text{A}$	-	15	-	
Gate - Collector Charge	$Q_{gc}$	$V_{GE} = 15\text{V}$	-	19	-	
Turn - on Delay Time	$t_{d(on)}$	$I_C = 25\text{A}, V_{CC} = 400\text{V}$	-	27	-	ns
Rise Time	$t_r$	$V_{GE} = 15\text{V}, R_G = 10\Omega$	-	38	-	
Turn - off Delay Time	$t_{d(off)}$	$T_j = 25^\circ\text{C}$	-	94	-	
Fall Time	$t_f$	Inductive Load	-	50	-	
Turn - on Delay Time	$t_{d(on)}$	$I_C = 25\text{A}, V_{CC} = 400\text{V}$	-	27	-	ns
Rise Time	$t_r$	$V_{GE} = 15\text{V}, R_G = 10\Omega$	-	38	-	
Turn - off Delay Time	$t_{d(off)}$	$T_j = 175^\circ\text{C}$	-	107	-	
Fall Time	$t_f$	Inductive Load	-	65	-	
Reverse Bias Safe Operating Area	RBSOA	$I_C = 100\text{A}, V_{CC} = 520\text{V}$ $V_P = 650\text{V}, V_{GE} = 15\text{V}$ $R_G = 60\Omega, T_j = 175^\circ\text{C}$	FULL SQUARE			-



●Electrical Characteristic Curves

Fig.1 Power Dissipation vs. Case Temperature

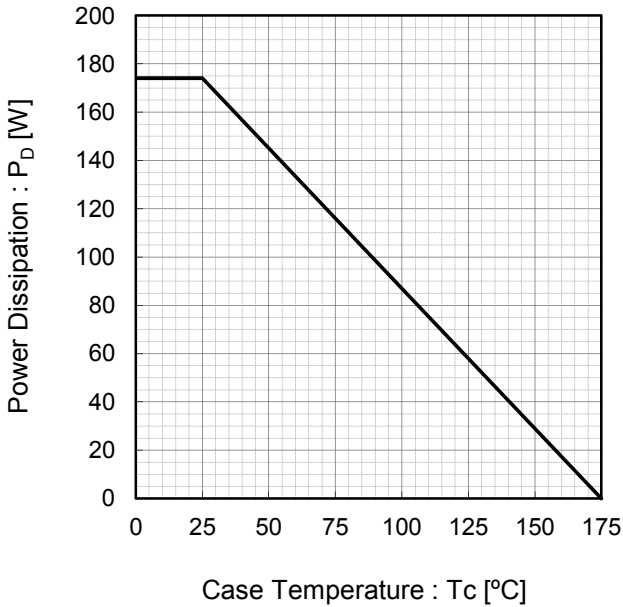


Fig.2 Collector Current vs. Case Temperature

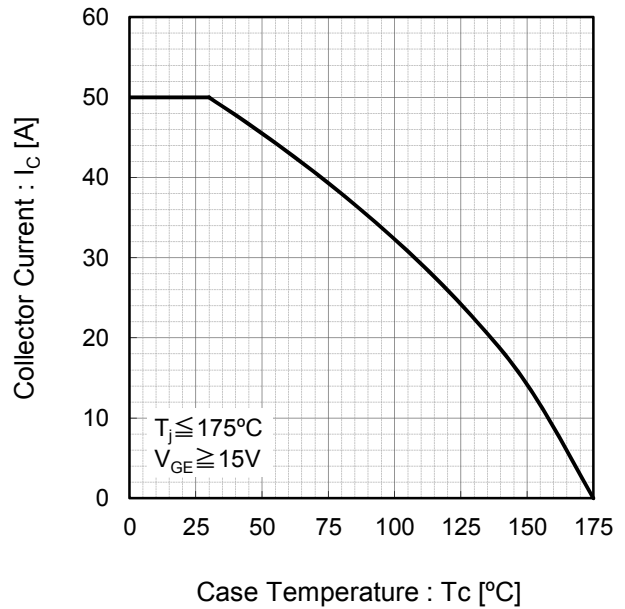


Fig.3 Forward Bias Safe Operating Area

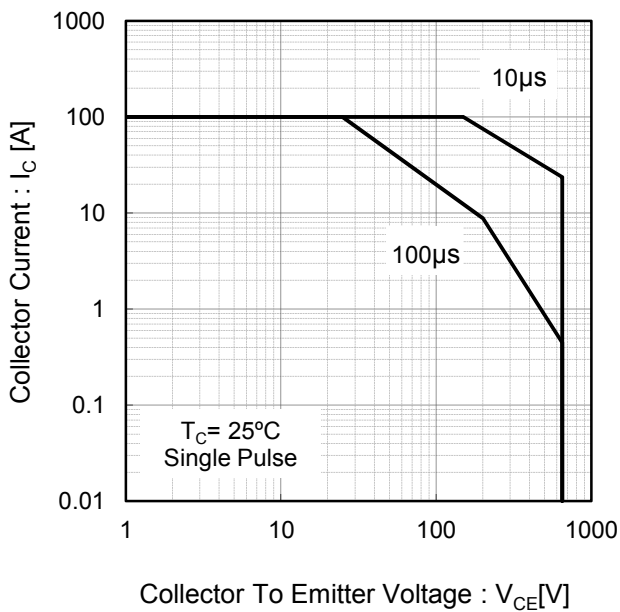
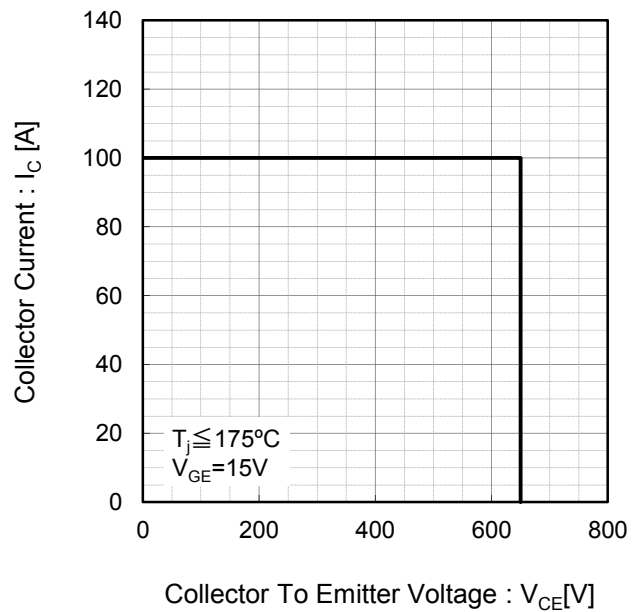


Fig.4 Reverse Bias Safe Operating Area



●Electrical Characteristic Curves

Fig.5 Typical Output Characteristics

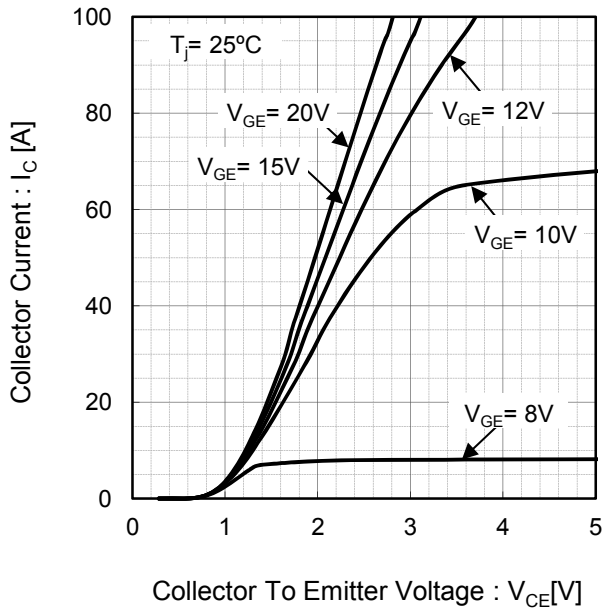


Fig.6 Typical Output Characteristics

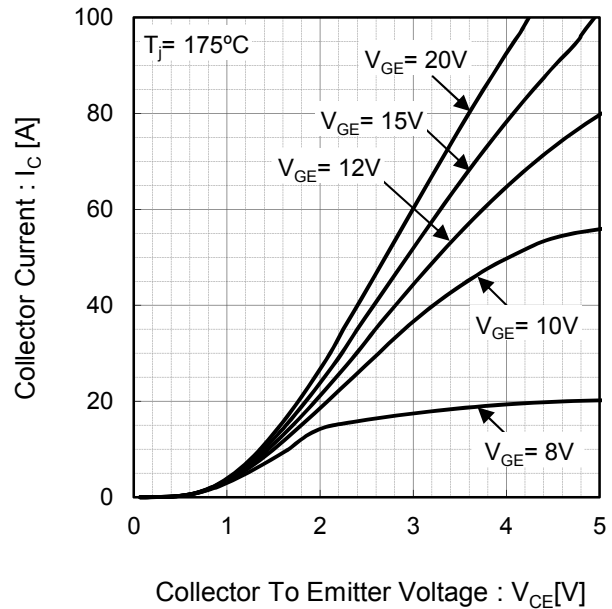


Fig.7 Typical Transfer Characteristics

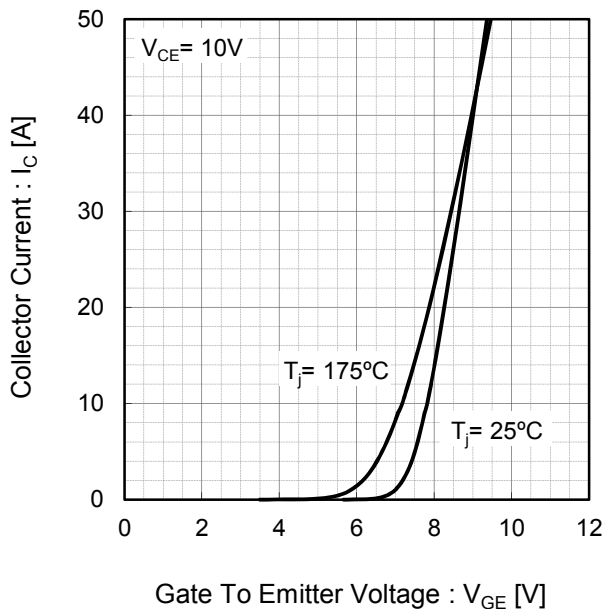
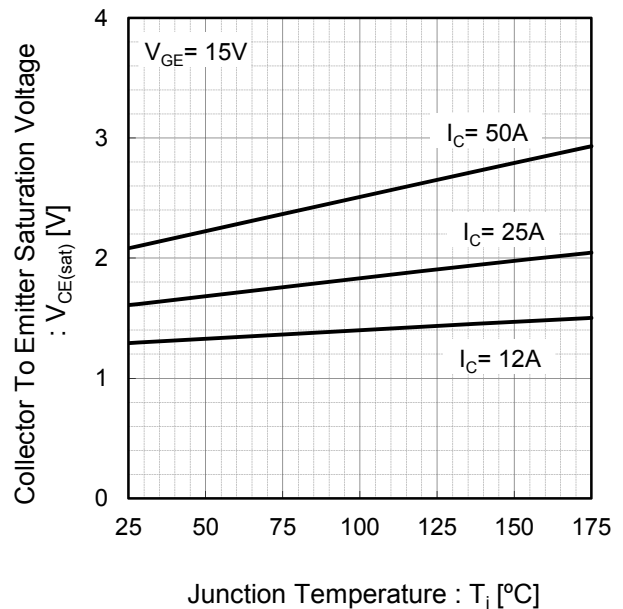


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature



●Electrical Characteristic Curves

Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

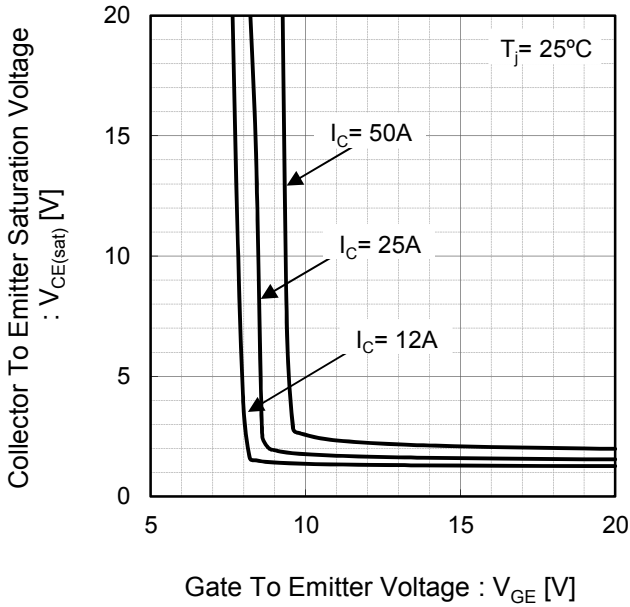


Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

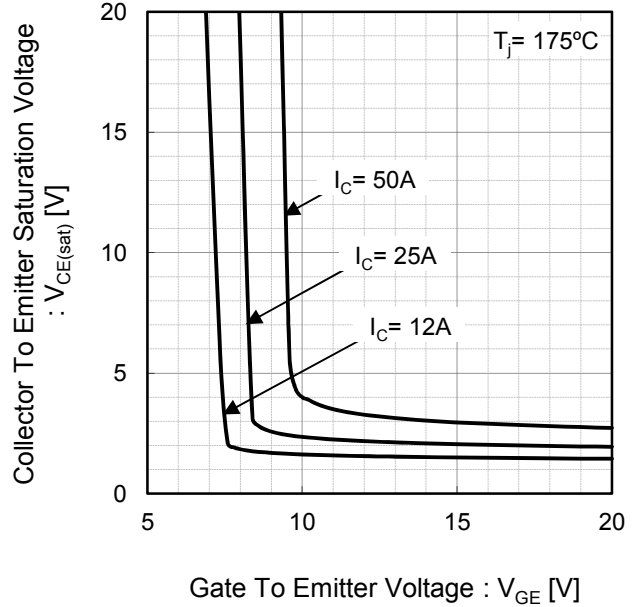


Fig.11 Typical Switching Time vs. Collector Current

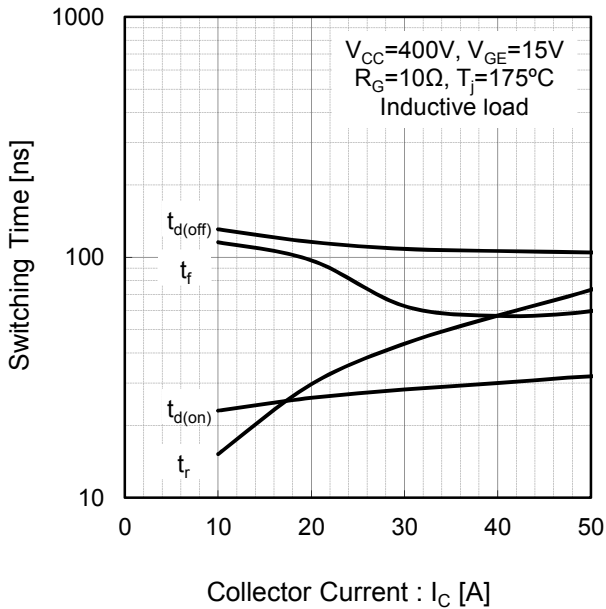
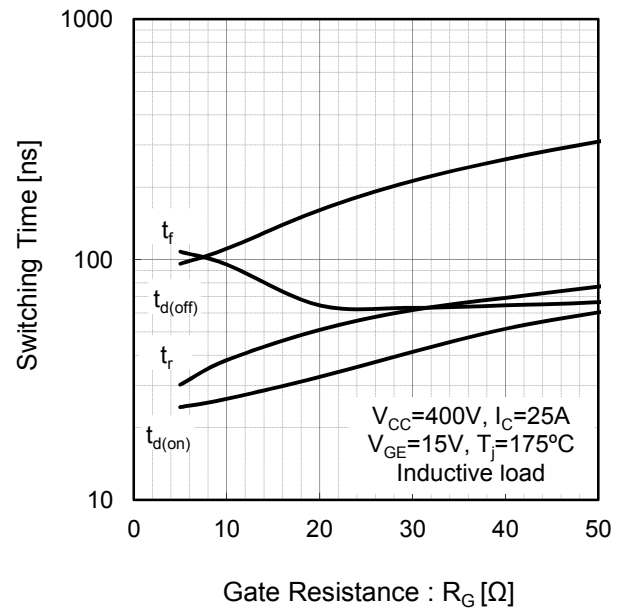


Fig.12 Typical Switching Time vs. Gate Resistance



●Electrical Characteristic Curves

Fig.13 Typical Switching Energy Losses vs. Collector Current

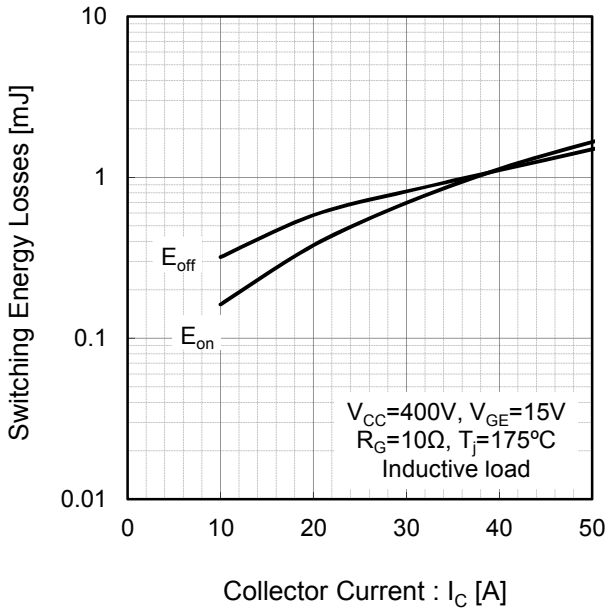


Fig.14 Typical Switching Energy Losses vs. Gate Resistance

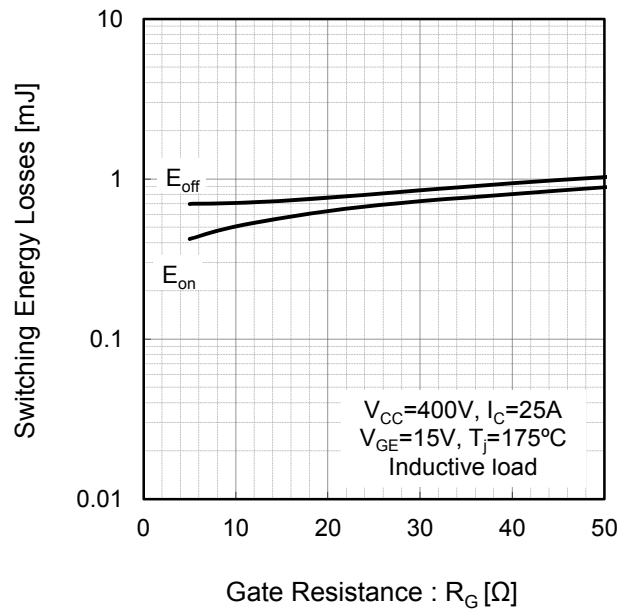


Fig.15 Typical Capacitance vs. Collector To Emitter Voltage

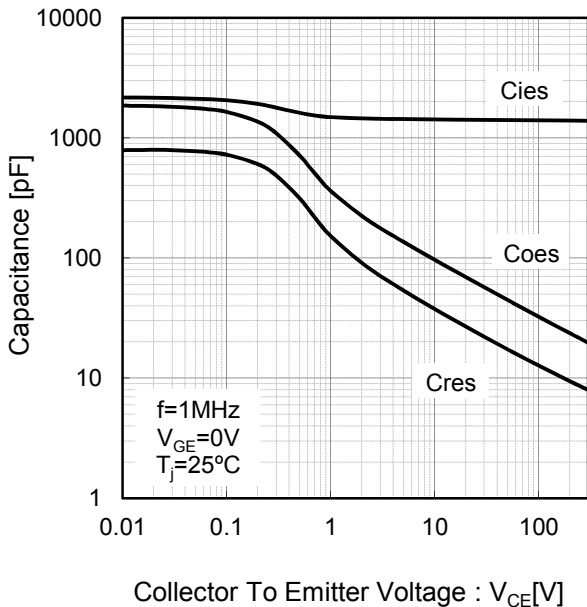
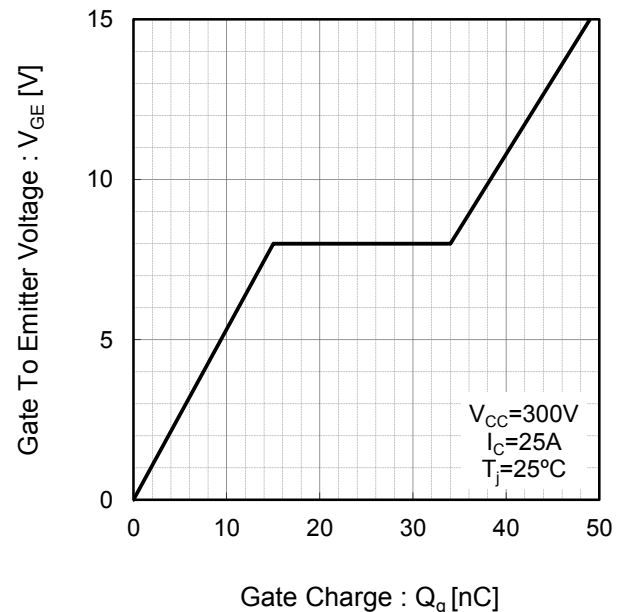


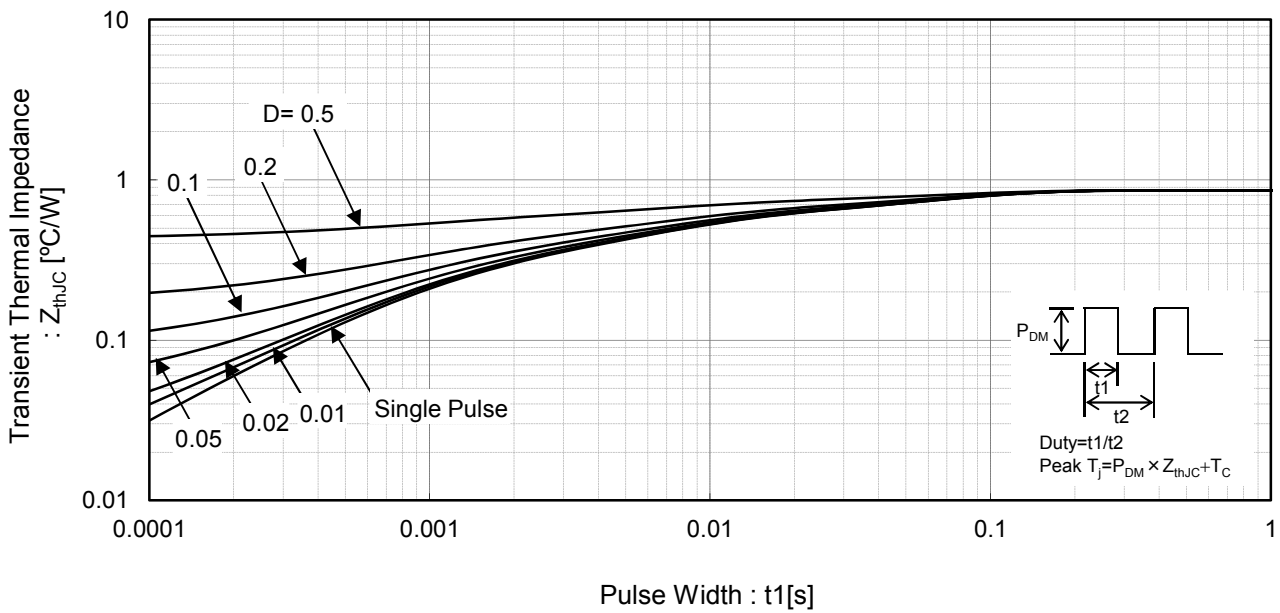
Fig.16 Typical Gate Charge





●Electrical Characteristic Curves

Fig.17 IGBT Transient Thermal Impedance



●Inductive Load Switching Circuit and Waveform

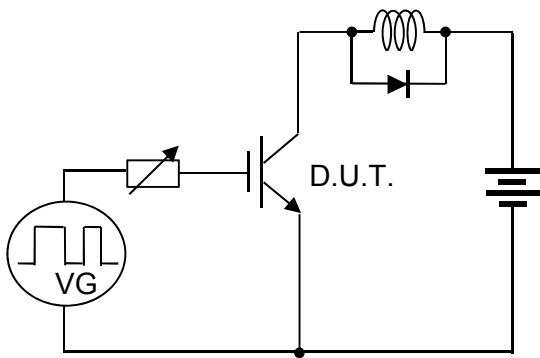


Fig.18 Inductive Load Circuit

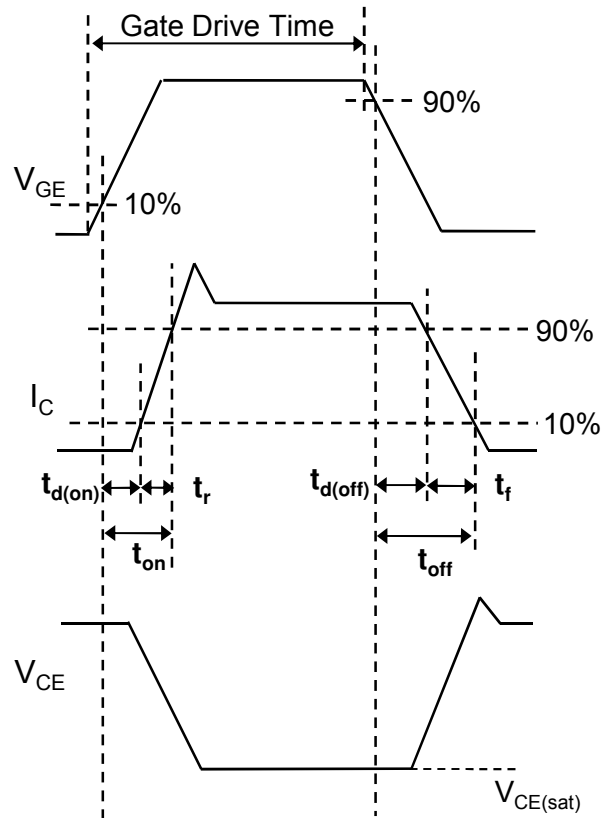


Fig.19 Inductive Load Waveform

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[Distribution Inventory](#)

Part Number	RGTH50TS65
Package	TO-247N
Unit Quantity	450
Minimum Package Quantity	450
Packing Type	Bulk
Constitution Materials List	inquiry
RoHS	Yes